U.S. Patent Application No.: Unknown

March 28, 2006

Page 5 of 10

AMENDMENTS TO THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the

application:

LISTING OF CLAIMS:

Claims 1-5 (canceled).

Claim 6 (new): A duplexer, comprising:

a transmission-side band filter including a plurality of surface acoustic wave

resonators connected together to define a ladder circuit:

a reception-side band filter including a plurality of surface acoustic wave

resonators connected together to define a ladder circuit; wherein

each of the plurality of surface acoustic wave resonators of the transmission-side

band filter and the reception-side band filter includes a 47° to 58° rotated, Y-cut, X-

propagating LiNbO<sub>3</sub> substrate and an IDT electrode provided on the LiNbO<sub>3</sub> substrate;

the IDT electrode includes a Ti foundation electrode layer disposed on the LiNbO<sub>3</sub> substrate and an Al electrode layer disposed on the Ti foundation electrode

laver; and

a (111) face of the Al electrode layer, one of a (001) face and (100) face of the Ti

foundation electrode layer, and a (001) face of the LiNbO3 substrate are aligned in

parallel.

Claim 7 (new): The duplexer according to Claim 6, where the Ti foundation

electrode layer is an epitaxially grown electrode layer on the LiNbO3 substrate and the

Al electrode layer is an epitaxially grown electrode layer on the Ti foundation electrode

laver.

U.S. Patent Application No.: Unknown

March 28, 2006

Page 6 of 10

Claim 8 (new): The duplexer according to Claim 6, wherein in the reception-side

band filter, a first inductance is disposed in parallel with respect to at least one serial

arm resonator connected to a serial arm of the ladder circuit among the plurality of

surface acoustic wave resonators, and in the transmission-side band filter, a second

inductance is disposed between a parallel arm resonator connected to a parallel arm of

the ladder circuit among the plurality of surface acoustic wave resonators and a ground

potential.

Claim 9 (new): The duplexer according to Claim 8, wherein the first inductance

and the second inductance are respectively defined by at least one of a wire bonding

used for electrical connection in the duplexer, a line embedded in the duplexer, and an

external coil component.

Claim 10 (new): The duplexer according to Claim 8, wherein the first inductance

and the second inductance are respectively defined by at least one of a wire bonding

used for electrical connection in the duplexer and a line embedded in the duplexer.

Claim 11 (new): The duplexer according to Claim 6, wherein the transmission-

side band filter includes three serial arm resonators and two parallel arm resonators

defining the ladder circuit.

Claim 12 (new): The duplexer according to Claim 6, wherein the reception-side

band filter includes three serial arm resonators and two parallel arm resonators defining

the ladder circuit.

U.S. Patent Application No.: Unknown

March 28, 2006

Page 7 of 10

Claim 13 (new): The duplexer according to Claim 6, wherein the LiNbO<sub>3</sub>

substrate is a 55° rotated, Y-cut, X-propagating LiNbO<sub>3</sub> substrate.

Claim 14 (new): A communication device, comprising the duplexer according to

Claim 6, wherein the duplexer includes an antenna terminal, an inductance is disposed

between the antennal terminal and an antenna, and the duplexer further includes a

capacitor connected between a connection point between the inductance and the

antenna and a ground potential.

Claim 15 (new): A duplexer, comprising:

a transmission-side band filter including a plurality of surface acoustic wave

resonators connected together to define a ladder circuit;

a reception-side band filter including a plurality of surface acoustic wave

resonators connected together to define a ladder circuit; wherein

each of the plurality of surface acoustic wave resonators of the transmission-side

band filter and the reception-side band filter includes a 47° to 58° rotated, Y-cut, X-

propagating LiNbO $_3$  substrate and an IDT electrode provided on the LiNbO $_3$  substrate;

the IDT electrode includes a Ti foundation electrode layer disposed on the

 $\mbox{LiNbO}_3$  substrate and an Al electrode layer disposed on the Ti foundation electrode

layer.

Claim 16 (new): The duplexer according to Claim 15, wherein a (111) face of the

Al electrode layer, one of a (001) face and (100) face of the Ti foundation electrode

layer, and a (001) face of the LiNbO<sub>3</sub> substrate are aligned in parallel.

U.S. Patent Application No.: Unknown

March 28, 2006

Page 8 of 10

Claim 17 (new): The duplexer according to Claim 15, where the Ti foundation

electrode layer is an epitaxially grown electrode layer on the LiNbO3 substrate and the

Al electrode layer is an epitaxially grown electrode layer on the Ti foundation electrode

layer.

Claim 18 (new): The duplexer according to Claim 15, wherein in the reception-

side band filter, a first inductance is disposed in parallel with respect to at least one

serial arm resonator connected to a serial arm of the ladder circuit among the plurality of

surface acoustic wave resonators, and in the transmission-side band filter, a second

inductance is disposed between a parallel arm resonator connected to a parallel arm of

the ladder circuit among the plurality of surface acoustic wave resonators and a ground

potential.

Claim 19 (new): The duplexer according to Claim 18, wherein the first

inductance and the second inductance are respectively defined by at least one of a wire

bonding used for electrical connection in the duplexer, a line embedded in the duplexer,

and an external coil component.

Claim 20 (new): The duplexer according to Claim 18, wherein the first

inductance and the second inductance are respectively defined by at least one of a wire

bonding used for electrical connection in the duplexer and a line embedded in the

duplexer.

U.S. Patent Application No.: Unknown

March 28, 2006

Page 9 of 10

Claim 21 (new): The duplexer according to Claim 15, wherein the transmission-

side band filter includes three serial arm resonators and two parallel arm resonators

defining the ladder circuit.

Claim 22 (new): The duplexer according to Claim 15, wherein the reception-side

band filter includes three serial arm resonators and two parallel arm resonators defining

the ladder circuit.

Claim 23 (new): The duplexer according to Claim 15, wherein the LiNbO<sub>3</sub>

substrate is a 55° rotated, Y-cut, X-propagating LiNbO<sub>3</sub> substrate.

Claim 24 (new): A communication device, comprising the duplexer according to

Claim 15, wherein the duplexer includes an antenna terminal and an antenna, a

inductance is disposed between the antennal terminal and the antenna, and the

duplexer further includes a capacitor connected between a connection point between

the inductance and the antenna and a ground potential.